IPC ASSOCIATION CONNECTELECTRONICS INDUSTRI	© Copyright 2005. IPC,	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute					Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information			
upplier Infor	rmation														
Company name*			Company unique ID			U	Unique ID Authority				Response Date*				
nsemi											2025-05-12				
Contact Name			Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-Env-Ste	wards	Product Enviro Compliance			ı	NA				Product-Env-Stewards@onsemi.com					
uthorized Repre	esentative*	Title - Representative			P	Phone - Representative*				Email - Representative*					
Product-Env-Ste	wards	Product Enviro Compliance			ı	NA				Product-Env-Stewards@onsemi.com					
Reque	ester Item Number	NCL30388A1DR2G		Number Mfr Item Name			Effective Da	te Version	ı	Manufacturing Site		Weight*	UOM	Unit Type	
				PFC Quasi-Resonant Primary Side Current- Mode Controller for LED Lighting with thermal foldback		urrent-	2025-05-12		PH1			71.87	mg	Each	
Ianufacturin	g Proccess Information	1													
Termin	Terminal Plating / Grid Array Material Ter			erminal Base Alloy J-STD-020 MSL Ratin		ting	Peak Process Body Temperature Max Time at Peak			k Temperature Number of Reflow Cycles					
Matte Tin (Sn) - annealed CU			CU Alloy 1				260 C 30			seconds 3					
omments															
vel 1 - maximun	n time at peak temperature o	during sol	dering is 10-3	0 seconds											
or more informa	ation regarding material con	position j	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	ous Material Weight Unit of Measure		Level	el Substance		Exempt	Weight	Unit of Measure	
Die	1.33	mg	Supplier	Silicon (Si)	7440-21-3		1.33	mg	
Die Attach	2.4	mg	Supplier	Silver (Ag)	7440-22-4		1.8	mg	
			Supplier	Epoxy resins	129915-35-1		0.6	mg	
Lead Frame	37.48		Supplier	Silver (Ag)	7440-22-4		0.7871	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.075	mg	
			Supplier	Iron (Fe)	7439-89-6		0.937	mg	
			Supplier	Copper (Cu)	7440-50-8		35.681	mg	
Mold Compound-Black	28.58			Epoxy resin	proprietary data		1.429	mg	
			Supplier	Phenolic Resin	Proprietary Data		0.5716	mg	
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.7145	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.1429	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		25.722	mg	
Plating	1.89	mg	Supplier	Tin (Sn)	7440-31-5		1.89	mg	
Wire Bond - Au	0.19	mg	Supplier	Gold (Au)	7440-57-5		0.19	mg	